Kunming, China (Nov. 6, 2020)

Panel Session

The impact of AI to the technology world, mainly from device and design perspectives.

My Position Statement Designer first, Al second.

Haruo Kobayashi

Gunma University, Japan

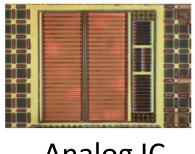


My Position Statement

In viewpoint of analog circuit design and testing

- Cooperation between designer and Al
- Practical use of Al

Analog circuit \rightarrow physical Not completely cyber \rightarrow Al cannot be 100%.



Analog IC

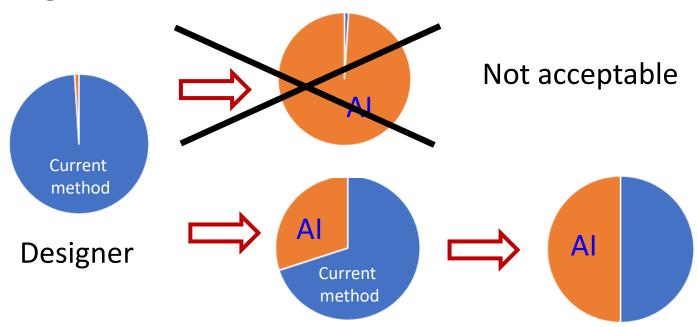


High reliability

A lot of know-how. Industry cannot accept 100% different method.

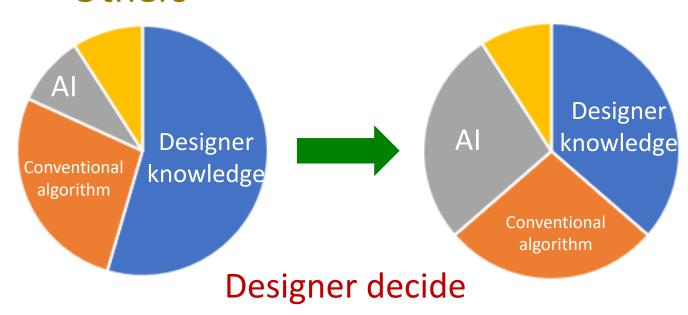
Practical Use of Al is Important

- Computer science researchers
- A lot of difficult words (buzzwords).
- Electronics researchers often claim
- Nothing has been achieved when booming is over.
- Designer-oriented Al



What should we do?

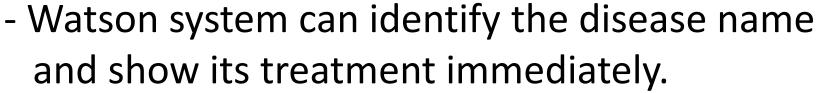
- Designer should be an excellent architect to consider
 - Designer's knowledge/experiences
 - EDA based on conventional algorithms
 - EDA based on Al
 - Others



IC Design Supported by AI

- IBM Watson System (Medical Area)
- A lot of medical research papers.







A lot of circuit design papers, text, patents,...







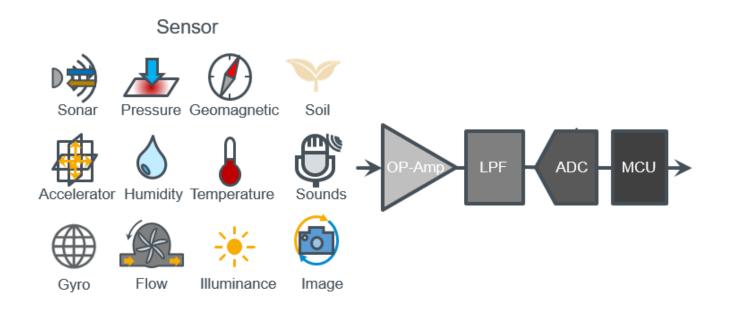


IoT System Design Supported by Al

loT system design with Al

Complicated system with a lot of sensors, analog interfaces, data storage and processors

Al might help optimum design of IoT system



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Question (5)

How would major technology trends, Al and IoT, would interact?

What would be their combined impact to our lives?

Dream of AI and IoT-Combined System

Future AI and IoT-combined system will solve such a difficult problem as COVID-19:

- collect useful information
 but with incomplete information
- show how to make its vaccine
- show when it is over
- show optimal strategy to society and economy

Hope it can solve unexperienced and unpredictable problems.

Machine cannot learn from the past

Al and IoT-Combined System

By considering COVID-19 problem, we might see

- potentials, possibilities
- technology limitation

of future AI and IoT-combined system.

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Question (10)

What new testing technique and methodology would be needed to support development of the AI chip?

Challenge of AI Chip Testing

- Al chip testing at mass production shipping
 - Based on customer demands
 - Al chip fast time-to-market
 - Balance of test quality and cost
 - Consider AI chip property
- Various Al Chips:
 - Their effective testing methods
 - Depending on AI chip
 - In some cases, use conventional test method in others, develop new method individually

High Performance Digital AI Chip

Digital AI Chip with high processing ability

Processing power



Twice every 3.5 months

- Consider its testing strategy
 from the beginning of AI chip design and layout
 for fast time-to-market
- Utilize AI chip property such as regularity of multi-processor cores
- Advanced device : Fin FET Own failure mode

Analog-related AI Chip

Ex. Computing-In-Memory as AI chip

New memory devices test challenges MRAM, ReRAM, FeRAM, PCM..
Many research papers in test conferences

 For consumer applications, testing with digital automatic test equipment (no analog option) for low cost test

Future Perspective

- Use all aspects of technologies
 - Circuit technique
 - Cooperation among BIST, BOST & ATE as well as software & network

Aristotelēs 「学問無王道」

- Signal processing algorithm
- Use resources in SOC such as μP core, memory, ADC/DAC

There is no science without measurement.

There is no production without test

No royal road to analog testing

H. Kobayashi, "Analog/Mixed-Signal Circuit Testing Technologies in IoT Era" ICSICT, Session B2 Analog 2 (Nov. 4, 2020)

Future Perspective

- Use all aspects of technologies
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 - Cooperation among BIST, BOST & ATE as well as software & network



Aristotelēs 「学問無王道」

- Signal processing algorithm
- Use resources in SO AI Chip such as μP core, memory, ADC/DAC,

Al core

There is no science without measurement.

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No royal road to analog testing



A lot of AI chip testing research challenges

Al can be everywhere in Testing

Example 1:

For PVT variation effect reduction

Self-Calibration in mixed-signal IC

Boundary between circuit design & test

Current: Adaptation algorithm

Al adopted: Learning algorithm

Example 2: Data compression technology in Al



Test time reduction, Defect saving

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